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## \*BIBDATASHEET\*

CONFIRMATION NO. 2279

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APPLICANTS

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\*\* CONTINUING DATA \*\*\*\*\*

*[Signature]* This application is a DIV of 09/772,752 01/30/2001 PAT 6,648,732

\*\* FOREIGN APPLICATIONS \*\*\*\*\*

*[Signature]*

IF REQUIRED, FOREIGN FILING LICENSE GRANTED  
 \*\* 12/30/2003

Foreign Priority claimed 35 USC 119 (a-d) conditions met Verified and Acknowledged	<input type="checkbox"/> yes <input type="checkbox"/> yes Allowance <i>[Signature]</i> Examiner's Signature	<input checked="" type="checkbox"/> no <input type="checkbox"/> no Met after Initials	STATE OR COUNTRY OR	SHEETS DRAWING 3	TOTAL CLAIMS 28	INDEPENDENT CLAIMS 5
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ADDRESS

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TITLE

Thin film coating of a slotted substrate and techniques for forming slotted substrates

FILING FEE	FEES: Authority has been given in Paper	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing )
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